

Preliminary

FAIRCHILD
SEMICONDUCTOR™

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FSTUD32211 40/48-Bit Bus Switch with -2V Undershoot Protection and Level Shifting (Preliminary)

General Description

The Fairchild Switch FSTUD32211 provides up to 48-bits of high-speed CMOS TTL-compatible bus switching. The low On Resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. A diode to V_{CC} has been integrated into the circuit to allow for level shifting between 5V inputs and 3.3V outputs.

The device can be organized as four 12-bit, two 24-bit, or one 48-bit bus switch. When routed as a 40-bit bus switch, the device can be organized as four 10-bit, two 20-bit or one 40-bit bus switch. When \overline{OE}_1 is LOW, the switch is ON and Port 1A is connected to Port 1B. When \overline{OE}_2 is LOW, the switch is ON and Port 2A is connected to Port 2B. When \overline{OE}_3 is LOW, the switch is ON and Port 3A is connected to Port 3B. When \overline{OE}_4 is LOW, the switch is ON and Port 4A is connected to Port 4B. When \overline{OE}_1 , \overline{OE}_2 , \overline{OE}_3 , or \overline{OE}_4 are HIGH, a high impedance state exists between the A and B Ports. The A and B Ports are protected against undershoot to support an extended range to 2.0V below ground. Fairchild's integrated Undershoot Hardened Circuit (UHC™) senses undershoot at the I/O's, and responds by preventing voltage differentials from developing and turning on the switch.

Features

- Undershoot protected to -2V (A and B Ports)
- Voltage level shifting
- 4Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control inputs compatible with TTL level
- See Applications Notes AN-5008 and AN-5021 for UHC details
- Packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

Ordering Code:

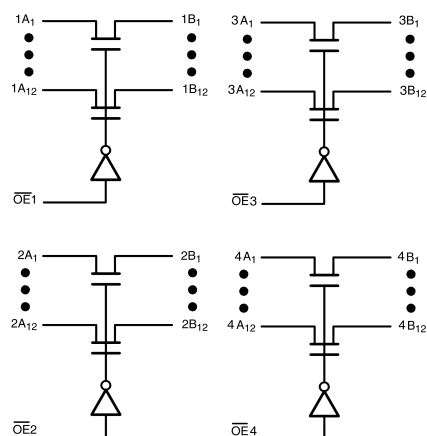
Order Number	Package Number	Package Description
FSTUD32211GX (Note 1)	BGA114A (Preliminary)	114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [Tape and Reel]

Note 1: BGA package available in Tape and Reel only.

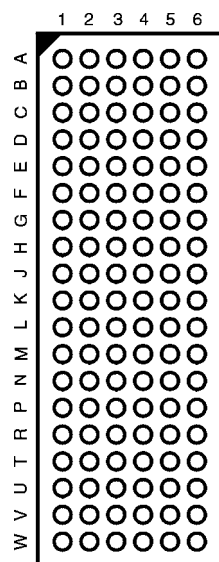
FSTUD32211 40/48-Bit Bus Switch with -2V Undershoot Protection and Level Shifting (Preliminary)



Logic Diagram



Connection Diagram



(Top Thru View)

Pin Descriptions

Pin Name	Description
$\overline{OE}_1, \overline{OE}_2, \overline{OE}_3, \overline{OE}_4$	Bus Switch Enables
1A, 2A, 3A, 4A	Bus A
1B, 2B, 3B, 4B	Bus B
NC	No Connect

FBGA Pin Assignments

(40-Bit Routing)

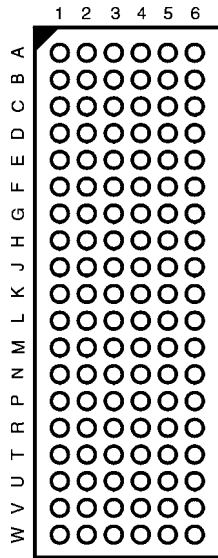
	1	2	3	4	5	6
A	1A ₂	1A ₁	NC	OE ₂	1B ₁	1B ₂
B	1A ₄	1A ₃	GND	OE ₁	1B ₃	1B ₄
C	1A ₆	1A ₅	GND	GND	1B ₅	1B ₆
D	1A ₈	1A ₇	GND	GND	1B ₇	1B ₈
E	1A ₁₀	1A ₉	V _{CC}	V _{CC}	1B ₉	1B ₁₀
F	2A ₂	2A ₁	V _{CC}	V _{CC}	2B ₁	2B ₂
G	2A ₄	2A ₃	V _{CC}	GND	2B ₃	2B ₄
H	2A ₆	2A ₅	GND	GND	2B ₅	2B ₆
J	2A ₈	2A ₇	2A ₉	2B ₉	2B ₇	2B ₈
K	2A ₁₀	3A ₁₀	GND	GND	3B ₁₀	2B ₁₀
L	3A ₉	3A ₈	GND	GND	3B ₈	3B ₉
M	3A ₇	3A ₆	GND	V _{CC}	3B ₆	3B ₇
N	3A ₅	3A ₄	V _{CC}	V _{CC}	3B ₄	3B ₅
P	3A ₃	3A ₂	V _{CC}	V _{CC}	3B ₂	3B ₃
R	3A ₁	4A ₁₀	GND	GND	4B ₁₀	3B ₁
T	4A ₉	4A ₈	GND	GND	4B ₈	4B ₉
U	4A ₇	4A ₆	GND	4B ₁	4B ₆	4B ₇
V	4A ₅	4A ₄	4A ₁	OE ₄	4B ₄	4B ₅
W	4A ₃	4A ₂	OE ₃	NC	4B ₂	4B ₃

Truth Tables

Inputs		Inputs/Outputs	
\overline{OE}_1	\overline{OE}_2	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

Inputs		Inputs/Outputs	
\overline{OE}_3	\overline{OE}_4	3A, 3B	4A, 4B
L	L	3A = 3B	4A = 4B
L	H	3A = 3B	Z
H	L	Z	4A = 4B
H	H	Z	Z

Connection Diagram



(Top Thru View)

Pin Descriptions

Pin Name	Description
$\overline{OE}_1, \overline{OE}_2, \overline{OE}_3, \overline{OE}_4$	Bus Switch Enables
1A, 2A, 3A, 4A	Bus A
1B, 2B, 3B, 4B	Bus B
NC	No Connect

FBGA Pin Assignments

(48-Bit Routing)

	1	2	3	4	5	6
A	1A ₂	1A ₁	NC	OE ₂	1B ₁	1B ₂
B	1A ₄	1A ₃	1A ₇	OE ₁	1B ₃	1B ₄
C	1A ₆	1A ₅	GND	1B ₇	1B ₅	1B ₆
D	1A ₁₀	1A ₉	1A ₈	1B ₈	1B ₉	1B ₁₀
E	1A ₁₂	1A ₁₁	2A ₁	2B ₁	1B ₁₁	1B ₁₂
F	2A ₄	2A ₃	2A ₂	2B ₂	2B ₃	2B ₄
G	2A ₆	2A ₅	V _{CC}	GND	2B ₅	2B ₆
H	2A ₈	2A ₇	GND	GND	2B ₇	2B ₈
J	2A ₁₀	2A ₉	2A ₁₁	2B ₁₁	2B ₉	2B ₁₀
K	2A ₁₂	3A ₁₂	GND	GND	3B ₁₂	2B ₁₂
L	3A ₁₁	3A ₁₀	GND	GND	3B ₁₀	3B ₁₁
M	3A ₉	3A ₈	GND	V _{CC}	3B ₈	3B ₉
N	3A ₇	3A ₆	3A ₂	3B ₂	3B ₆	3B ₇
P	3A ₅	3A ₄	3A ₁	3B ₁	3B ₄	3B ₅
R	3A ₃	4A ₁₂	4A ₈	4B ₈	4B ₁₂	3B ₃
T	4A ₁₁	4A ₁₀	4A ₇	4B ₇	4B ₁₀	4B ₁₁
U	4A ₉	4A ₆	GND	4B ₁	4B ₆	4B ₉
V	4A ₅	4A ₄	4A ₁	OE ₄	4B ₄	4B ₅
W	4A ₃	4A ₂	OE ₃	NC	4B ₂	4B ₃

Truth Tables

Inputs		Inputs/Outputs	
\overline{OE}_1	\overline{OE}_2	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

Inputs		Inputs/Outputs	
\overline{OE}_3	\overline{OE}_4	3A, 3B	4A, 4B
L	L	3A = 3B	4A = 4B
L	H	3A = 3B	Z
H	L	Z	4A = 4B
H	H	Z	Z

Absolute Maximum Ratings(Note 2)

Supply Voltage (V_{CC})	0.5V to +7.0V
DC Switch Voltage (V_S) (Note 3)	-2V to +7.0V
DC Input Control Pin Voltage (V_{IN})(Note 4)	-0.5V to +7.0V
DC Input Diode Current (I_{IK}) $V_{IN} < 0V$	-50 mA
DC Output (I_{OUT})	128 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	+/- 100 mA
Storage Temperature Range (T_{STG})	-65°C to +150 °C

Recommended Operating Conditions (Note 5)

Power Supply Operating (V_{CC})	4.5V to 5.5V
Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to 5.5V
Input Rise and Fall Time (t_r, t_f)	
Switch Control Input	0 ns/V to 5 ns/V
Switch I/O	0 ns/V to DC
Free Air Operating Temperature (T_A)	-40°C to +85°C

Note 2: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 3: V_S is the voltage observed/applied at either A or B Ports across the switch.

Note 4: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 5: Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$			Units	Conditions
			Min	Typ (Note 6)	Max		
V_{IK}	Clamp Diode Voltage	4.5			-1.2	V	$I_{IN} = -18\text{ mA}$
V_{IH}	HIGH Level Input Voltage	4.5 - 5.5	2.0			V	
V_{IL}	LOW Level Input Voltage	4.5 - 5.5			0.8	V	
V_{OH}	HIGH Level	4.5 - 5.5	See Figure 4			V	
I_I	Input Leakage Current	5.5			± 1.0	μA	$0 \leq V_{IN} \leq 5.5V$
		0			10	μA	$V_{IN} = 5.5V$
I_{OZ}	OFF-STATE Leakage Current	5.5			± 1.0	μA	$0 \leq A, B \leq V_{CC}$
R_{ON}	Switch On Resistance (Note 7)	4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 64\text{ mA}$
		4.5		4	7	Ω	$V_{IN} = 0V, I_{IN} = 30\text{ mA}$
		4.5		35	50	Ω	$V_{IN} = 2.4V, I_{IN} = 15\text{ mA}$
I_{CC}	Quiescent Supply Current	5.5			1.5	mA	$OE_1 = OE_2 = GND$ $V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$
					10	μA	$OE_1 = OE_2 = V_{CC}$ $V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$
ΔI_{CC}	Increase in I_{CC} per Input	5.5			2.5	mA	One Input at 3.4V Other Inputs at V_{CC} or GND
V_{IKU}	Voltage Undershoot	5.5			-2.0	V	$0.0\text{ mA} \geq I_{IN} \geq -50\text{ mA}$ $OE_{1,2} = 5.5V$

Note 6: Typical values are at $V_{CC} = 5.0V$ and $T_A = +25^\circ\text{C}$

Note 7: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Electrical Characteristics

Symbol	Parameter	T _A = -40 °C to +85 °C, C _L = 50pF, RU = RD = 500Ω		Units	Conditions	Figure Number
		V _{CC} = 4.5 – 5.5V				
		Min	Max			
t _{PHL} , t _{PLH}	Propagation Delay Bus to Bus (Note 8)		0.25	ns	V _I = OPEN	Figures 2, 3
t _{PZH} , t _{PZL}	Output Enable Time	1.5	10.0	ns	V _I = 7V for t _{PZL} V _I = OPEN for t _{PZH}	Figures 2, 3
t _{PHZ} , t _{PLZ}	Output Disable Time	1.5	9.0	ns	V _I = 7V for t _{PLZ} V _I = OPEN for t _{PHZ}	Figures 2, 3

Note 8: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Capacitance (Note 9)

Symbol	Parameter	Typ	Max	Units	Conditions
C _{IN}	Control Pin Input Capacitance	3		pF	V _{CC} = 5.0V
C _{I/O}	Input/Output Capacitance	6		pF	V _{CC} , OE = 5.0V

Note 9: T_A = +25°C, f = 1 MHz, Capacitance is characterized but not tested.

Undershoot Characteristic (Note 10)

Symbol	Parameter	Min	Typ	Max	Units	Conditions
V _{OUTU}	Output Voltage During Undershoot	2.5	V _{OH} - 0.3		V	Figure 1

Note 10: This test is intended to characterize the device's protective capabilities by maintaining output signal integrity during an input transient voltage undershoot event.

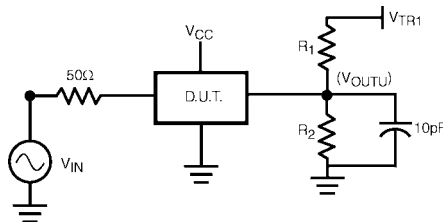
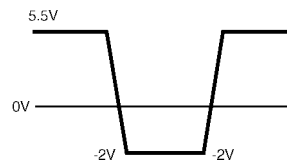


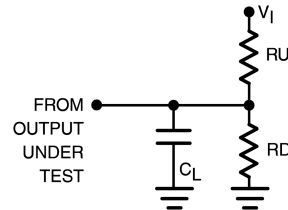
FIGURE 1.

Device Test Conditions

Parameter	Value	Units
V _{IN}	see Waveforms	V
R ₁ = R ₂	100K	Ω
V _{TRI}	11.0	V
V _{CC}	5.5	V

Transient Input Voltage (V_{IN}) Waveform

AC Loading and Waveforms



Note: Input driven by 50Ω source terminated in 50Ω

Note: C_L includes load and stray capacitance

Note: Input PRR = 1.0 MHz, $t_W = 500$ ns

FIGURE 2. AC Test Circuit

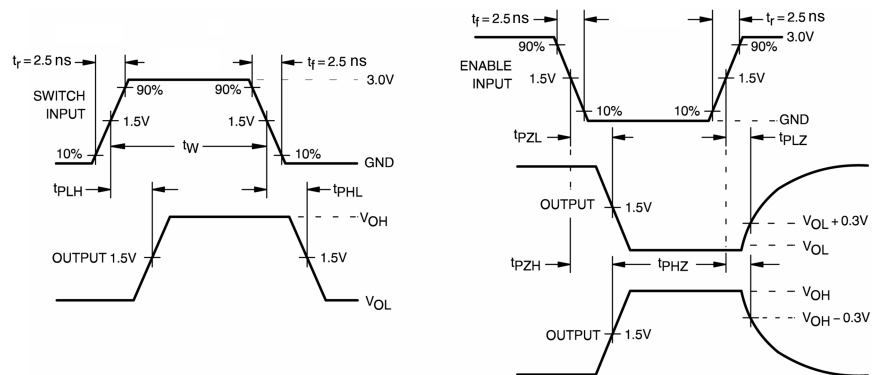


FIGURE 3. AC Waveforms

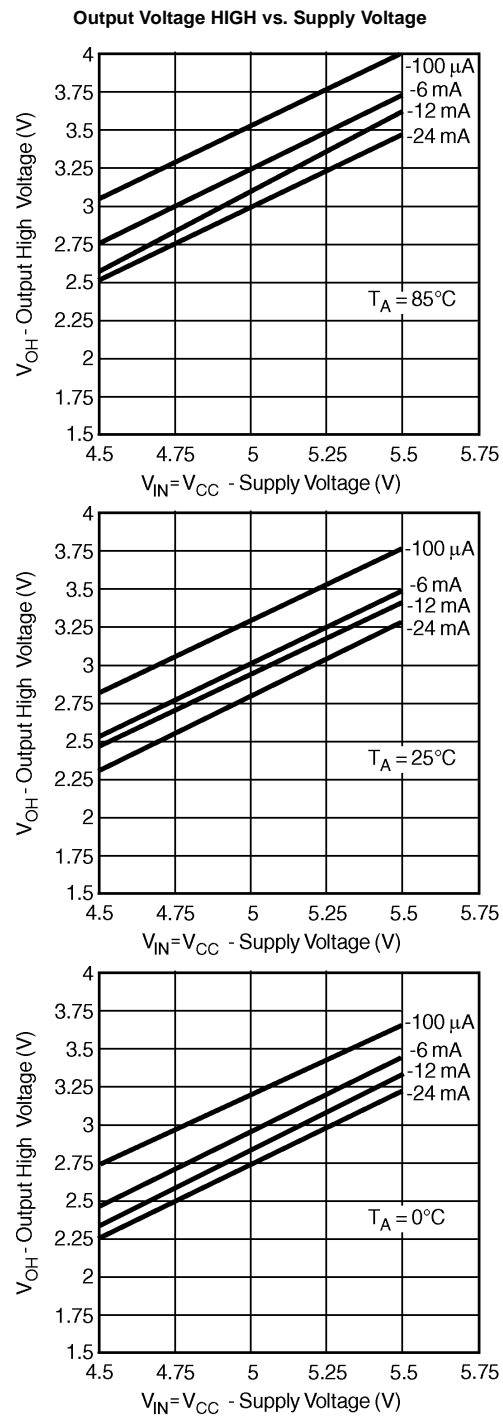
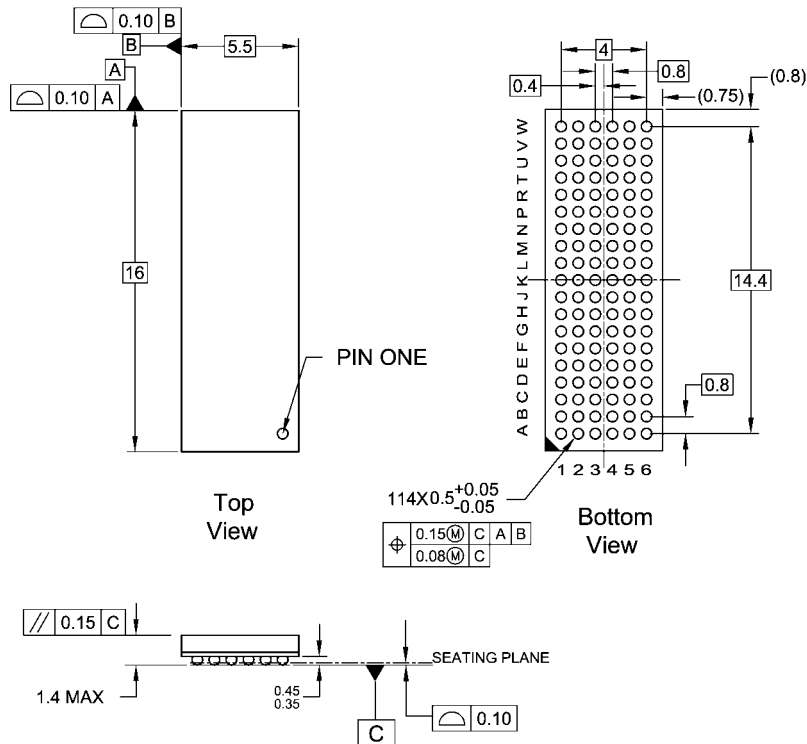


FIGURE 4.

Preliminary

Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC M0-205
- B. ALL DIMENSIONS IN MILLIMETERS
- C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
.35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
- D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA114ArevE

114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
Package Number BGA114A
Preliminary

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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